## **EAST Search History (Prior Art)**

Ref #	Hits	Search Query	DBs	Defa ult Oper ator	Plurals	Time Stamp
L1	3376	(134/94.1,95.1,95.2,95.3,144,157).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2010/06/16 16:57
L4	944	I1 and (semiconductor or wafer or substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2010/06/16 16:58
L6	308	I4 and nozzle mix\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2010/06/16 16:59
L7	72	I4 and nozzle mix\$3 near6 gas\$4 near7 (liquid or water)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2010/06/16 16:59
L8	33	I4 and nozzle near10 mix\$3 near6 gas\$4 near7 (liquid or water)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2010/06/16 17:00